### 8.0SMDJ Series Surface Mount - 8000W





### **Agency Recognitions**

Agency	Agency File Number
<b>FU</b> :	E230531

### **Maximum Ratings and Thermal Characteristics**

(T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at T <sub>1</sub> =25°C by 10/1000µs Waveform (Fig.2)(Note 1), (Note 2)	P <sub>PPM</sub>	8000	W
Power Dissipation on Infinite Heat Sink at $T_L$ =50°C	$P_{\scriptscriptstyle D}$	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I <sub>FSM</sub>	300	А
Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only	V <sub>F</sub>	5.0	V
Operating Temperature Range	$T_{J}$	-65 to 150	°C
Storage Temperature Range	$T_{STG}$	-65 to 175	°C
Typical Thermal Resistance Junction to Lead	$R_{\theta JL}$	15	°C/W
Typical Thermal Resistance Junction to Ambient	$R_{_{\theta JA}}$	75	°C/W

- 1. Non-repetitive current pulse , per Fig. 4 and derated above T, (initial) =25°C per Fig. 3.
- 2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal
- 3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional component only, duty cycle=4 per minute maximum

### **Description**

The 8.0SMDJ series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

### **Features and Benefits**

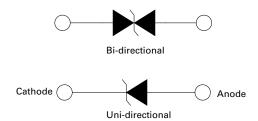
- For surface mounted applications to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air). 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-
- EFT protection of data lines in accordance with IEC 61000-
- Built-in strain relief
- Glass passivated chip junction
- 8kW peak pulse power capability at 10/1000µs waveform, repetition rate (duty Pb-free E3 means 2nd level cycles):0.01%
- Fast response time: typically less than 1.0ps from 0V to VBR min

- Excellent clamping capability
- Compact size with high power density in DO-214AB Package
- Low incremental surge resistance
- Typical IR less than 5µA when  $V_{RR}$  min>22V
- High temperature reflow soldering guaranteed: 260°C/40sec
- $V_{BB}$  @  $T_{J} = V_{BB}$  @  $25^{\circ}$  C x  $(1+\alpha T)$  $\times (T_1 - 25))(\alpha T: Temperature)$ Coefficient, typical value is 0.1%
- UL Recognized compound meeting flammability rating V-0
- Meet MSL level1, per J-STD-020, LF maximun peak of 260°C
- Matte tin lead–free plated
- Halogen free and RoHS compliant
- interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

### **Applications**

TVS components are ideal for the protection of I/O Interfaces, VCC bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

### **Functional Diagram**





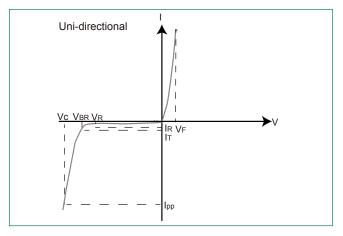
### Electrical Characteristics ( $T_A$ =25°C unless otherwise noted)

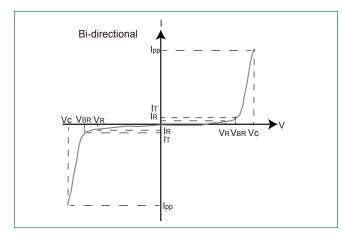
Part Number (Uni)	Part Number (Bi)	Mar	king	Reverse Stand off Voltage	Volta	down geV <sub>BR</sub> s) @ I <sub>T</sub>	Test Current	Maximum Clamping Voltage V <sub>c</sub> @ I <sub>pp</sub>	Maximum Peak Pulse Current I <sub>pp</sub> (10/1000µs)	Maximum Clamping Voltage V <sub>c</sub> @ I	Maximum Peak Pulse Current I	Maximum Reverse Leakage I <sub>R</sub>	Agency Approval
(Om)	(61)	UNI	ВІ	V <sub>R</sub> (Volts)	MIN	MAX	(mA)	(10/1000µs) (V)	(A)	(8/20µs) (V)	(A)	(μ <b>A</b> )	<b>71</b>
8.0SMDJ12A	8.0SMDJ12CA	8PEP	8BEP	12	13.3	14.7	10	19.9	402.1	25.7	2613.7	800	X
8.0SMDJ13A	8.0SMDJ13CA	8PEQ	8BEQ	13	14.4	15.9	10	21.5	372.1	27.8	2418.7	500	X
8.0SMDJ14A	8.0SMDJ14CA	8PER	8BER	14	15.6	17.2	10	23.2	344.9	30.0	2241.9	200	X
8.0SMDJ15A	8.0SMDJ15CA	8PES	8BES	15	16.7	18.5	1	24.4	327.9	31.5	2131.4	100	Χ
8.0SMDJ16A	8.0SMDJ16CA	8PET	8BET	16	17.8	19.7	1	26.0	307.7	33.6	2000.1	50	X
8.0SMDJ17A	8.0SMDJ17CA	8PEU	8BEU	17	18.9	20.9	1	27.6	290.0	35.7	1885.0	20	Χ
8.0SMDJ18A	8.0SMDJ18CA	8PEV	8BEV	18	20.0	22.1	1	29.2	274.0	37.7	1781.0	10	X
8.0SMDJ20A	8.0SMDJ20CA	8PEW	8BEW	20	22.2	24.5	1	32.4	247.0	41.9	1605.5	5	X
8.0SMDJ22A	8.0SMDJ22CA	8PEX	8BEX	22	24.4	26.9	1	35.5	225.4	45.9	1464.8	5	X
8.0SMDJ24A	8.0SMDJ24CA	8PEZ	8BEZ	24	26.7	29.5	1	38.9	205.7	50.3	1336.8	5	X
8.0SMDJ26A	8.0SMDJ26CA	8PFE	8BFE	26	28.9	31.9	1	42.1	190.1	54.4	1235.7	5	X
8.0SMDJ28A	8.0SMDJ28CA	8PFG	8BFG	28	31.1	34.4	1	45.4	176.2	58.7	1145.4	5	X
8.0SMDJ30A	8.0SMDJ30CA	8PFK	8BFK	30	33.3	36.8	1	48.4	165.3	62.5	1074.5	5	X
8.0SMDJ33A	8.0SMDJ33CA	8PFM	8BFM	33	36.7	40.6	1	53.3	150.1	68.9	975.7	5	Χ
8.0SMDJ36A	8.0SMDJ36CA	8PFP	8BFP	36	40.0	44.2	1	58.1	137.8	75.1	895.7	5	X
8.0SMDJ40A	8.0SMDJ40CA	8PFR	8BFR	40	44.4	49.1	1	64.5	124.1	83.3	806.7	5	X
8.0SMDJ43A	8.0SMDJ43CA	8PFT	8BFT	43	47.8	52.8	1	69.4	115.3	89.7	749.5	5	X
8.0SMDJ45A	8.0SMDJ45CA	8PFV	8BFV	45	50.0	55.3	1	72.7	110.1	93.9	715.7	5	Χ
8.0SMDJ48A	8.0SMDJ48CA	8PFX	8BFX	48	53.3	58.9	1	77.4	103.4	100.0	671.8	5	X
8.0SMDJ51A	8.0SMDJ51CA	8PFZ	8BFZ	51	56.7	62.7	1	82.4	97.1	106.5	631.2	5	X
8.0SMDJ54A	8.0SMDJ54CA	8PGE	8BGE	54	60.0	66.3	1	87.1	92.0	112.5	598.0	5	X
8.0SMDJ58A	8.0SMDJ58CA	8PGG	8BGG	58	64.4	71.2	1	93.6	85.5	120.9	555.8	5	X
8.0SMDJ60A	8.0SMDJ60CA	8PGK	8BGK	60	66.7	73.7	1	96.8	82.7	125.1	537.2	5	X
8.0SMDJ64A	8.0SMDJ64CA	8PGM	8BGM	64	71.1	78.6	1	103.0	77.7	133.1	504.9	5	X
8.0SMDJ70A	8.0SMDJ70CA	8PGP	8BGB	70	77.8	86.0	1	113.0	71.0	146.0	461.5	5	X
8.0SMDJ75A	8.0SMDJ75CA	8PGR	8BGR	75	83.3	92.1	1	121.0	66.2	156.3	430.3	5	X
8.0SMDJ78A	8.0SMDJ78CA	8PGT	8BGT	78	86.7	95.8	1	126.0	63.5	162.8	412.8	5	X
8.0SMDJ85A	8.0SMDJ85CA	8PGV	8BGV	85	94.4	104.0	1	137.0	58.4	177.0	379.6	5	X
8.0SMDJ90A	8.0SMDJ90CA	8PGX	8BGX	90	100.0	111.0	1	146.0	55.0	188.6	357.5	5	X
8.0SMDJ100A	8.0SMDJ100CA	8PGZ	8BGZ	100	111.0	123.0	1	162.0	49.4	209.3	321.1	5	X
8.0SMDJ110A	8.0SMDJ110CA	8PHE	8BHE	110	122.0	135.0	1	177.0	45.2	228.7	293.8	5	Χ

For bidirectional type having  $\rm V_{R}$  of 20 volts and less, the  $\rm I_{R}$  limit is double.



### **I-V Curve Characteristics**





- $\boldsymbol{P}_{\boldsymbol{PPM}}$  Peak Pulse Power Dissipation -- Max power dissipation
- V<sub>B</sub> Stand-off Voltage -- Maximum voltage that can be applied to the TVS without operation
- V<sub>BB</sub> Breakdown Voltage -- Maximum voltage that flows though the TVS at a specified test current (I<sub>x</sub>)
- V<sub>c</sub> Clamping Voltage -- Peak voltage measured across the TVS at a specified I<sub>PPM</sub> (peak impulse current)
- Reverse Leakage Current -- Current measured at V<sub>B</sub>
- V Forward Voltage Drop for Uni-directional

### Ratings and Characteristic Curves ( $T_A = 25$ °C unless otherwise noted)

**Figure 1:**TVS Transients Clamping Waveform

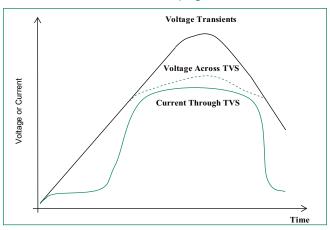
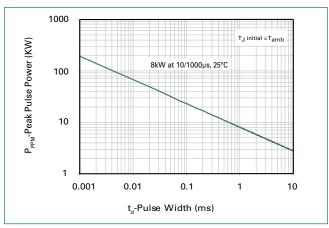


Figure 2: Peak Pulse Power Rating



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### Ratings and Characteristic Curves (T<sub>A</sub>=25°C unless otherwise noted) (Continued)

**Figure 3:** Peak Pulse Power Derating Curve

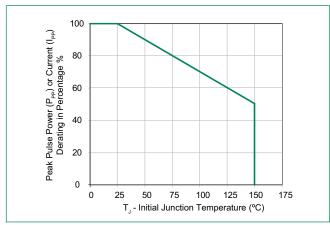


Figure 5:
Typical Junction Capacitance

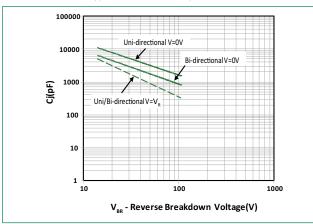
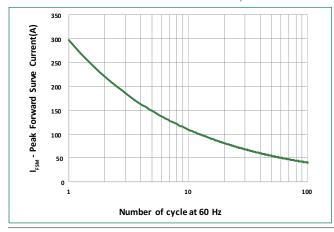
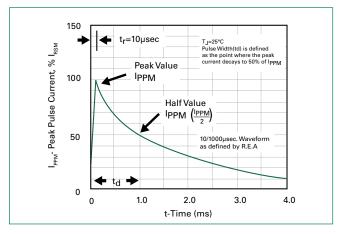


Figure 7:

Maximum Non-Repetitive Peak Forward Surge
Current Uni-Directional Only



**Figure 4:** Pulse Waveform



**Figure 6:** Typical Transient Thermal Impedance

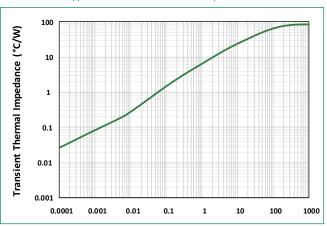
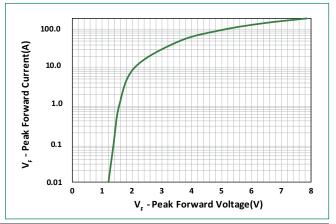


Figure 8:
Peak Forward Voltage Drop vs Peak Forward
Current (Typical Values)

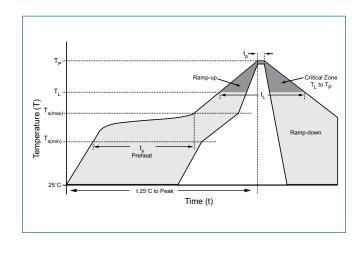




## **8.0SMDJ Series**Surface Mount – 8000W

### **Soldering Parameters**

Reflow Cond	lition	Lead-free assembly		
	- Temperature Min (T <sub>s(min)</sub> )	150°C		
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C		
	-Time (min to max) (t <sub>s</sub> )	60 – 120 secs		
Average ram peak	p up rate (Liquidus Temp (T <sub>A</sub> ) to	3°C/second max		
T <sub>S(max)</sub> to T <sub>A</sub> -	Ramp-up Rate	3°C/second max		
Reflow	- Temperature (T <sub>L</sub> ) (Liquidus)	217°C		
	-Time (min to max) (t <sub>L</sub> )	60 – 150 seconds		
Peak Temper	rature (T <sub>p</sub> )	260 <sup>+0/-5</sup> °C		
Time within (t <sub>p</sub> )	5°C of actual peak Temperature	30 seconds		
Ramp-down	Rate	6°C/second max		
Time 25°C to	peak Temperature (T <sub>P</sub> )	8 minutes Max.		
Do not exce	ed	260°C		



### **Physical Specifications**

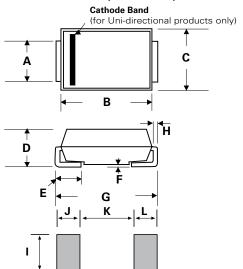
Weight	0.011 ounce ,0.3 grams
Case	JEDEC DO214AB. Molded plastic body over glass passivated junction
Polarity	Color band denotes positive end (cathode) except Bidirectional.
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102

### **Environmental Specifications**

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-A111

### **Dimensions**

### DO-214AB (SMC J-Bend)



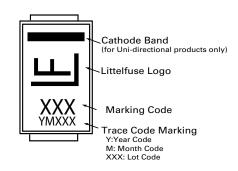
Dimensions	Incl	hes	Millimeters			
	Min	Max	Min	Max		
А	0.114	0.126	2.900	3.200		
В	0.260	0.280	6.600	7.110		
С	0.220	0.245	5.590	6.220		
D	0.079	0.103	2.060	2.620		
Е	0.030	0.060	0.760	1.520		
F	-	0.008	-	0.203		
G	0.305	0.320	7.750	8.130		
Н	0.006	0.012	0.152	0.305		
1	0.129	-	3.300	-		
J	0.094	-	2.400	-		
K	-	0.165	-	4.200		
L	0.094	-	2.400	-		



### **Part Numbering System**

# 8.0SMDJ XXX C A 5% V<sub>BR</sub> VOLTAGE TOLERANCE BI-DIRECTIONAL V<sub>R</sub> VOLTAGE

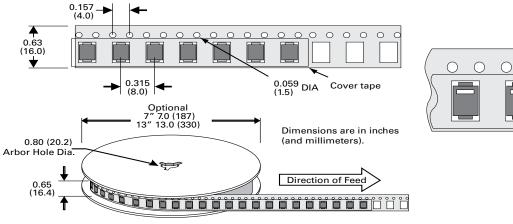
### **Part Marking System**

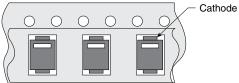


### **Packaging Options**

Part number	Component Package	Quantity	Packaging Option	Packaging Specification	
8.0SMDJxxxXX	DO-214AB	3000	Tape & Reel - 16mm tape/13" reel	EIA STD RS-481	
8.0SMDJxxxXX-T7	DO-214AB	500	Tape & Reel – 16mm tape/7" reel	EIA STD RS-481	

### **Tape and Reel Specification**





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